

P-Channel 30-V (D-S) MOSFET

PRODU	CT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ.)				
- 30	0.0092 at V_{GS} = - 10 V	- 60	29.5 nC				
- 30	0.0128 at V_{GS} = - 4.5 V	- 55	29.5 IC				

TO-220AB

G D S

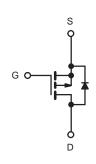
Top View

FEATURES

- Halogen-free
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested

APPLICATIONS

- Load Switch
- Notebook Adaptor Switch



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_{μ}	$= 25 ^{\circ}\text{C}$, unless othe	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	- 30	V
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		- 60.5	
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C		- 55.9	
$Continuous Drain Current (T_j = 150 C)$	T _A = 25 °C	I _D	- 55.9 ^{a, b}	
	T _A = 70 °C		-45.6 ^{a, b}	^
Pulsed Drain Current		I _{DM}	- 60	A
	T _C = 25 °C		- 4.1	
Continuous Source-Drain Diode Current	T _A = 25 °C	Is	- 2.2 ^{a, b}	
Avalanche Current		I _{AS}	- 20	
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	20	mJ
	T _C = 25 °C		5.0	
Maximum Dawar Dissinction	T _C = 70 °C	D_	3.2	W
Maximum Power Dissipation	T _A = 25 °C	P _D	2.7 ^{a, b}	vv
	T _A = 70 °C	1	1.7 ^{a, b}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	38	46	°C/W
Maximum Junction-to-Foot	Steady State	R _{thJF}	20	25	0/11

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 85 $^{\circ}\text{C/W}.$

d. Based on T_C = 25 °C.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	lp = - 250 µA		- 34		mV/
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		5.3		°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			± 100	nA
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	<u> </u>
Zero Gate Voltage Drain Current	IDSS	V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C	Т _Ј = 55 °С		- 5	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 30			Α
	-	V _{GS} = - 10 V, I _D = - 10 A		0.008		Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 8 A		0.011		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 10 A		28		S
Dynamic ^b		· · · · · · · · · · · · · · · · · · ·				
Input Capacitance	C _{iss}			2550		
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		455		pF
Reverse Transfer Capacitance	C _{rss}			390		
T (10 (0)		V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 10 A		57	86	86
Total Gate Charge	Q_g			29.5	45	
Gate-Source Charge	Q _{as}	V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 10 A		8		nC
Gate-Drain Charge	Q _{gd}			22		
Gate Resistance	R _g	f = 1 MHz	0.5	2.2	4.4	Ω
Turn-On Delay Time	t _{d(on)}			13	25	
Rise Time	t _r	V_{DD} = - 15 V, R _L = 1.5 Ω		12	24	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω		40	70	
Fall Time	t _f	, i i i i i i i i i i i i i i i i i i i		9	18	
Turn-On Delay Time	t _{d(on)}			48	80	ns
Rise Time	t _r	V_{DD} = - 15 V, R _L = 1.5 Ω		92	160	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		34	60	
Fall Time	t _f			19	35	
Drain-Source Body Diode Characteris	stics					
Continous Source-Drain Diode Current	١ _s	T _C = 25 °C			- 4.1	^
Pulse Diode Forward Current	I _{SM}	-			- 60	A
Body Diode Voltage	V _{SD}	I _S = - 3 A, V _{GS} = 0 V		- 0.75	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}			27	45	ns
Body Diode Reverse Recovery Charge	Q _{rr}			16	27	nC
Reverse Recovery Fall Time	t _a	I _F = - 10 A, dI/dt = 100 A/μs, T _J = 25 °C		12		
Reverse Recovery Rise Time	t _b			15		ns

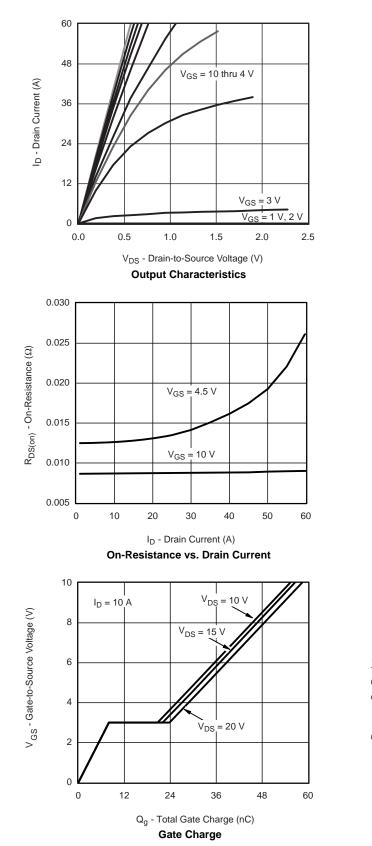
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

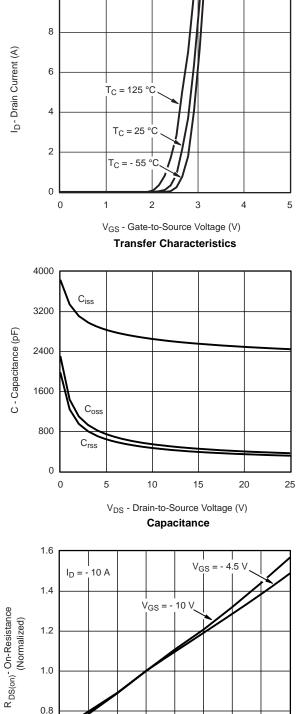
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



10

0.6

- 50

- 25

0

25

50

On-Resistance vs. Junction Temperature

T_J - Junction Temperature (°C)

75

100

125

150

³



I_D = 10 A

T_J = 25 °C

10

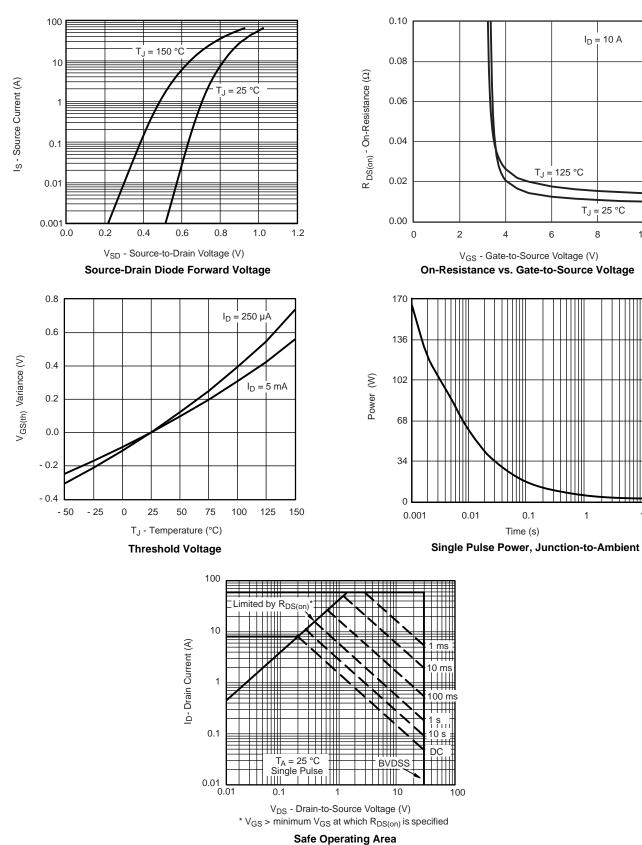
10

8

1

T_J = 125 °C

6

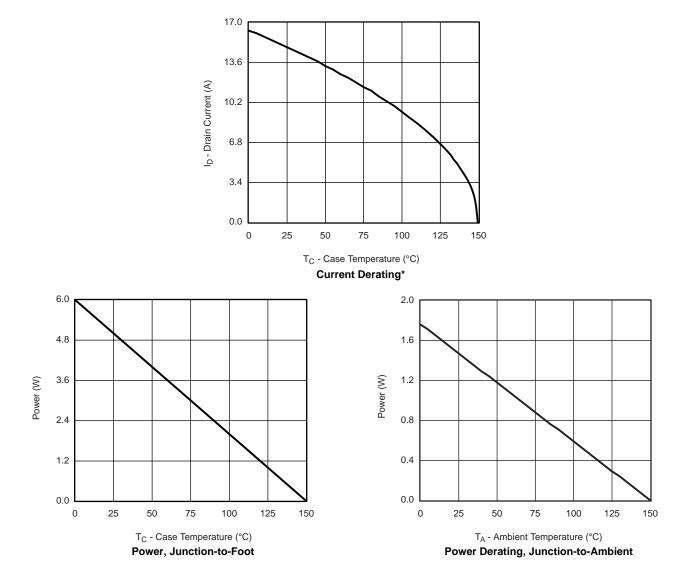


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





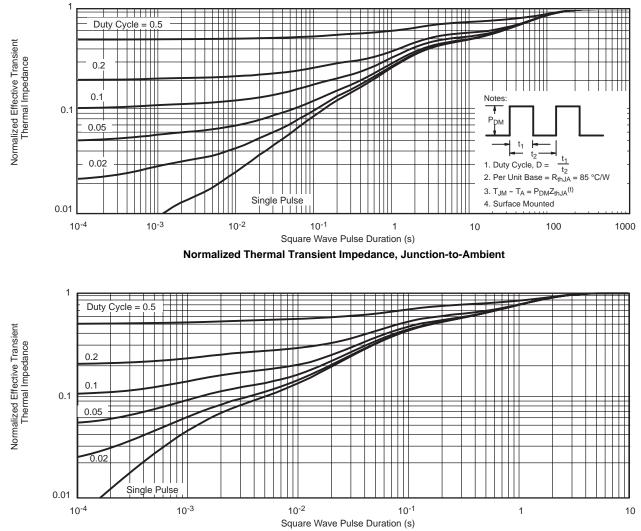
MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



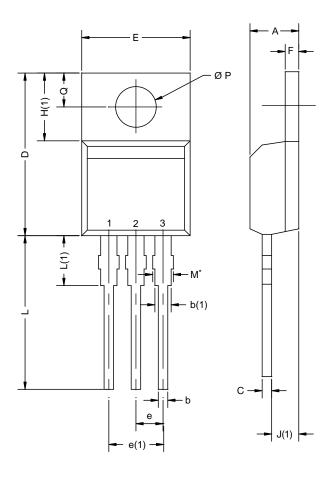




Normalized Thermal Transient Impedance, Junction-to-Foot



TO-220AB



	MILLIN	MILLIMETERS INCH		
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØР	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
ECN: X12- DWG: 547	-0208-Rev. N, 1	08-Oct-12		

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

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